ANALOGDEVICES

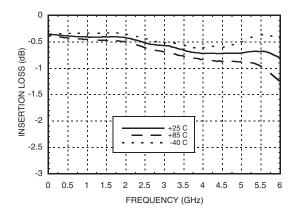
HMC467LP3 / 467LP3E

v01.0705

ROHS V

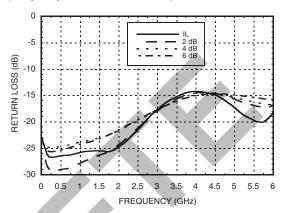
2 dB LSB GaAs MMIC 2-BIT DIGITAL POSITIVE CONTROL ATTENUATOR, DC - 6 GHz

Insertion Loss



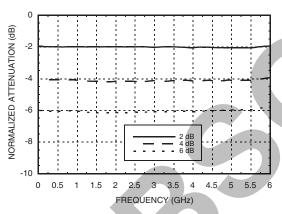
Return Loss RF1, RF2

(Only Major States are Shown)

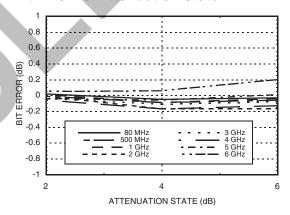


Normalized Attenuation

(Only Major States are Shown)

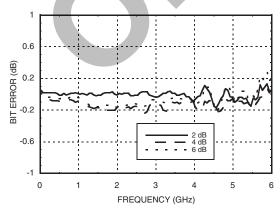


Bit Error vs. Attenuation State



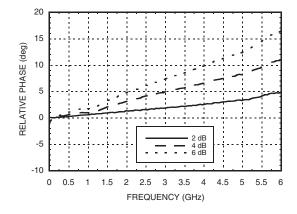
Bit Error vs. Frequency

(Only Major States are Shown)



Relative Phase vs. Frequency

(Only Major States are Shown)



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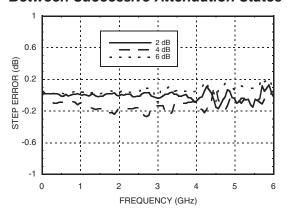
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Worst Case Step Error Between Successive Attenuation States



Truth Table

Control Voltage Input			
V1 4 dB	V2 2 dB	Attenuation Setting RF1 - RF2	
High	High	Reference I.L.	
High	Low	2 dB	
Low	High	4 dB	
Low	Low	6 dB Max. Atten.	

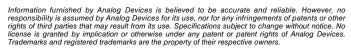
Any combination of the above states will provide an attenuation approximately equal to the sum of the bits selected.

Bias Voltage & Current

V	dd Range=	+5.0 Vdc ± 1	0%
Vdd (Vdc)		d (Typ.) (mA)	Idd (Max.) (mA)
+5.0		0.7	1.2

TTL/CMOS Control Voltages

State	Bias Condition
Low	0 to 0.8 Vdc @ -5 uA Typ.
High	+2.0 to +5.0 Vdc @ 40 uA Typ.







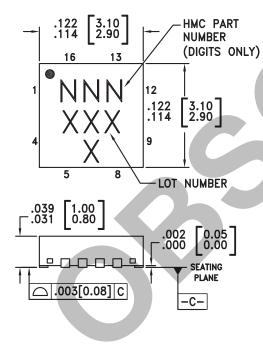
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Absolute Maximum Ratings

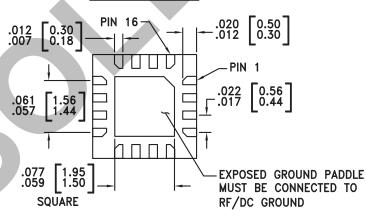
Control Voltage (V1, V2)	-0.5 Vdc to Vdd +1 Vdc	
Bias Voltage (Vdd)	+7.0 Vdc	
Staorage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	
RF Input Power	+30 dBm	
ESD Sensitivity (HBM)	Class 1A	



Outline Drawing



BOTTOM VIEW



NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC467LP3	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	467 XXXX
HMC467LP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	<u>467</u> XXXX

- [1] Max peak reflow temperature of 235 $^{\circ}\text{C}$
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX

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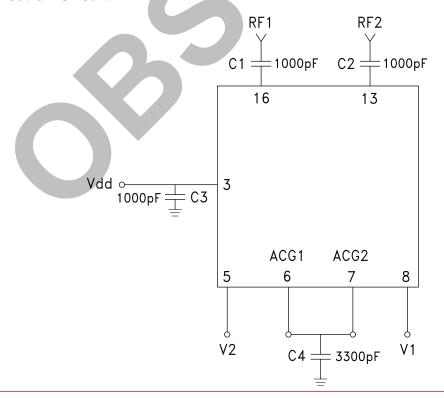


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Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 2, 4, 9 - 12, 14, 15	N/C	These pins should be connected to PCB RF ground to maximize performance.	
3	Vdd	Supply Voltage	
5, 8	V2, V1	See truth table and control voltage table.	V1 133K (V2) - = = =
6, 7	ACG1, ACG2	External capacitor to ground is required. Select value for lowest frequency of operation. Place capacitor as close to pins as possible.	
13, 16	RF2, RF1	These pins are DC coupled and matched to 50 Ohm. Blocking capacitors are required.	(RF1) (RF2)
	GND	Package bottom has an exposed metal paddle that must be connected to RF/DC ground.	O GND =

Application Circuit



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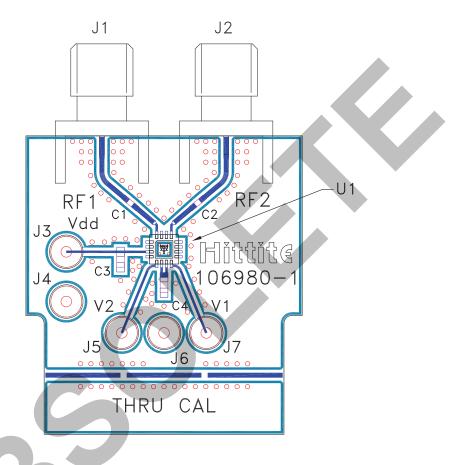
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ROHS V

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Evaluation PCB



List of Materials for Evaluation PCB 107008 [1]

Item		Description	
J1 - J2		PCB Mount SMA Connector	
J3 - J7		DC Pin	
C1, C2		1000 pF Capacitor, 0402 Pkg.	
C3		1000 pF Capacitor, 0603 Pkg.	
C4	3300 pF Capacitor, 0603 Pkg.		
U1		HMC467LP3 / HMC467LP3E Digital Attenuator	
PCB [2]		106980 Evaluation PCB	

^[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.